Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
L28	2053841	substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 09:58
L29	4313898	component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 09:58
L30	16795	wiring near substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 09:58
L31	497	"conductive paste" and L28 and L29 and L30	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 09:59
L38	21	("3757175" | "4494100" | "5416356" | "5481131" | "5530288" | "5598032" | "5710458" | "5747870" | "5936299" | "5939783" | "6005466" | "6218729").PN. OR ("6310386").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/31 10:36
L39	0	"semicondcutor chip" with (saw or "surfac acoustic wave filter") with decoder with switch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:02
L40	0	"semiconductor chip" with (saw or "surfac acoustic wave filter") with decoder with switch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:03
L41	1	"semiconductor chip" with (saw or "surface acoustic wave filter") with decoder with switch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/31 11:03

L42	21	("3757175" | "4494100" | "5416356" | "5481131" | "5530288" | "5598032" | "5710458" | "5747870" | "5936299" | "5939783" | "6005466" | "6218729").PN. OR ("6310386").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/31 11:05
S2	173514	("surface acoustic wave filter" or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 09:39
S3	4997	("surface acoustic wave filter")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 09:39
S4	2658	("surface acoustic wave filter").ti.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 09:40
S5	145	("surface acoustic wave filter").ti. and gap	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/06/29 09:40
S7	1800	361/760.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:05
S8	2053841	substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:05
S9	4313898	component	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:05

S10	2104946	electronic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:05
S11	560	S7 and S8 and S9 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:06
S12	2080850	resin	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:06
S13	267	S11 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:21
S14	111133	(semiconductor or semi$conductor) near chip	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:24
S15	175597	("surface acoustic wave filter" or saw)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:35
S16	756	S15 and S14 and S8 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:25
S17	473	S16 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:26

S18	16795	wiring near substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:26
S19	121	S18 and S15 and S14 and S8 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:28
S20	101	S19 and S10	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:27
S21	121	S18 and S15 and S14 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 15:29
S22	5103	("surface acoustic wave filter")	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:02
S24	5	("20020049042" | "6072122" | "6114413" | "6320543" | "6630727").PN. OR ("6794747"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 15:55
S25	5	("20020049042" | "6072122" | "6114413" | "6320543" | "6630727").PN. OR ("6794747"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 15:58
S26	43	S22 and S14 and S12	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 16:03
S27	20	("4737742" | "5406235" | "5459368" | "5929510" | "6038133" | "6060960" | "6181015" | "6285559" | "6456172").PN. OR ("6570469").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 16:17

S28	10	("20010008794" | "20020053730" | "20040119166" | "20040159933" | "20040178570" | "5870289" | "6005401" | "6184121" | "6309912" | "6319754").PN. OR ("6930392"). URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 16:41
S29	792	333/193.ccls.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 16:41
S31	111	S7 and S9 and S12 and S14	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 17:09
S32	260	("4792646" | "5136366" | "5153385" | "5241133").PN. OR ("5355283").URPN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 17:16
S33	4569	RF near device	US-PGPUB; USPAT; USOCR	OR	ON	2005/08/30 17:17
S37	84536	("radio frequency" or rf) near signal	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 17:35
S39	2171857	switch	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 17:36
S41	65	S39 and S14 and S15 and S37	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/08/30 17:38